

Full name of sixth inventor (given name, family name)

Inventor's signature Manabu Imose

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600
IMOSE Manabu
Date June 3, 2005

Citizenship Japan

Full name of seventh inventor (given name, family name)

Inventor's signature _____

Residence _____

Post Office Address _____

Date _____

Citizenship _____

Full name of eighth inventor (given name, family name)

Inventor's signature _____

Residence _____

Post Office Address _____

Date _____

Citizenship _____

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

23850

PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, ' 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)

Full name of sole or first inventor (given name, family name) 100 OHKOSHI Toshio
Inventor's signature Toshio Ohkoshi Date June 3, 2005
Residence Nishikamo-gun, Aichi 470-0206, Japan JPX Citizenship Japan
Post Office Address c/o KANSAI PAINT CO., LTD., 1, Aza Hirachi, Oaza Azabu, Miyoshi-cho,
Nishikamo-gun, Aichi 470-0206, Japan

Full name of second inventor (given name, family name) 200 TAKEDA Hiroki
Inventor's signature Hiroki Takeda Date June 3, 2005
Residence Nishikamo-gun, Aichi 470-0206, Japan JPX Citizenship Japan
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Full name of third inventor (given name, family name) 300 KATO Yoshinori
Inventor's signature Yoshinori Kato Date June 3, 2005
Residence Nishikamo-gun, Aichi 470-0206, Japan JPX Citizenship Japan
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Full name of fourth inventor (given name, family name) 400 NAKAMURA Masahiro
Inventor's signature Masahiro Nakamura Date June 3, 2005
Residence Toyota-shi, Aichi 471-8571, Japan JPX Citizenship Japan
Post Office Address c/o TOYOTA JIDOSHA KABUSHIKI KAISHA, 1, Toyota-cho, Toyota-shi,
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Full name of fifth inventor (given name, family name) 500 HARADA Masayoshi
Inventor's signature Masayoshi Harada Date June 3, 2005
Residence Osaka-shi, Osaka 533-0031, Japan JPX Citizenship Japan
Post Office Address c/o KUBOKO PAINT CO., LTD., 15-27, Nishiawaji 3-chome,
Higashiyodogawa-ku, Osaka-shi, Osaka 533-0031, Japan

DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: _____

METHOD OF FORMING COATING FILM ON ALUMINUM SUBSTRATE

the specification of which is attached hereto unless the following is checked

☒ was filed on December 19, 2003 as United States Application Number or PCT International

Application Number PCT/JP2003/016302 and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) – (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed.

(List prior foreign applications. See note A)

2002-369599
(Number)

Japan
(Country)

20/12/2002
(Day/Month/Year Filed)

Priority Claimed

☒ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(Number)

(Country)

(Day/Month/Year Filed)

☐ Yes ☐ No

(See note B)

☐ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List prior U.S. Applications)

Status

(Application Serial No.)

(Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

(Application Serial No.)

(Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

(Application Serial No.)

(Filing Date)

☐ Patented ☐ Pending ☐ Abandoned

10539120

VERIFICATION OF TRANSLATION **JC20 Rec'd PCT/PTO 1 6 JUN 2005**

I, the below named translator, hereby declare that:

My name and post office address are as stated below:

That I am knowledgeable in the English language and in the language in which the below identified international application was filed, and that I believe the English translation of the international application No. PCT/JP2003/016302 is a true and complete translation of the above identified international application as filed.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Date

June 3, 2005

Full name of the translator

Hideki MORI

Signature of the translator

Hideki Mori

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